PD IEC/PAS 61182-12:2014

BSI Standards Publication

Generic requirements for printed board assembly products manufacturing description data and transfer methodology

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National foreword

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The UK participation in its preparation was entrusted to Technical Committee EPL/501, Electronic assembly technology & Printed Electronics.

A list of organizations represented on this committee can be obtained on request to its secretary.

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Published by BSI Standards Limited 2014

ISBN 978 0 580 86595 4
ICS 33.180.01

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This Published Document was published under the authority of the Standards Policy and Strategy Committee on 31 October 2014.

Amendments/corrigenda issued since publication

Date	Text affected

IEC PAS 61182-12

Edition 1.0 2014-08

PUBLICLY AVAILABLE SPECIFICATION

PRE-STANDARD

colour inside

Generic requirements for printed board assembly products manufacturing description data and transfer methodology

INTERNATIONAL ELECTROTECHNICAL COMMISSION

PRICE CODE XH

ICS 31.180

ISBN 978-2-8322-1804-4

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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GENERIC REQUIREMENTS FOR PRINTED BOARD ASSEMBLY PRODUCTS MANUFACTURING DESCRIPTION DATA AND TRANSFER METHODOLOGY

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The text of this PAS is based on the following document:	This PAS was approved for publication by the P-members of the committee concerned as indicated in the following document
Draft PAS	**Report on voting**
91/1182/PAS	91/1192/RVD

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Generic Requirements for Printed Board Assembly Products Manufacturing Description Data and Transfer Methodology

1 SCOPE

This standard specifies the XML schema that represents the intelligent data file format used to describe printed board and printed board assembly products with details sufficient for tooling, manufacturing, assembly, and inspection requirements. This format may be used for transmitting information between a printed board designer and a manufacturing or assembly facility. The data is most useful when the manufacturing cycle includes computer-aided processes and numerical control machines.

The data can be defined in either English or International System of Units (SI) units. The format is a convergence of the IPC-2511 “GenCAM” and the Valor Computerized Systems “ODB-X” format structure.

1.1 Focus and intent

The generic format requirements are provided in a series of standards focused on printed board manufacturing, assembly, and inspection testing. This standard series consists of a generic standard (IPC-2581) that contains all the general requirements. There are seven sectional standards that are focused on the XML details necessary to accumulate information in the single file, that addresses the needs of the manufacturing disciplines producing a particular product.

The sectional standards (IPC-2582 through 2588) paraphrase the important requirements and provide suggested usage and examples for the topic covered by the sectional standard.

1.2 Notation

Although the data would be contained in a single file, the file can have different purposes as described in Section 4. The XML schema used for this standard follows the notations set forth by the W3C and is as follows:

element – Element appears exactly one time

element? – Element may appear 0 or 1 times

element* – Element may appear 0 or more times

element+ – Element may appear 1 or more times

Any IPC-258X file is composed of a high level element (IPC-2581) that contains up to six sub-elements:

Content – information about the contents of the 258X file

LogisticHeader – information pertaining to the order and supply data

HistoryRec – change information of the file

Bom – Bill of Materials (Material List) information

Ecad – Computer Aided Design (engineering) information

Avl – Approved Vendors List information